



## SCHOLARSHIP INFORMATION AND APPLICATION

### TAPPI CORRUGATED DIVISION MEMORIAL SCHOLARSHIPS

The purpose of the TAPPI Scholarship Program is to recognize academic excellence, increase awareness and participation in TAPPI's member groups and to attract talented individuals to the industry segments that TAPPI serves.

**Note:** This scholarship application is specifically for those candidates applying for the Joe Dieffenbacher Engineering Memorial Scholarship and/or the Terry S. Paulson Memorial Scholarship. The deadline for completed applications for these two scholarships is February 15. For all other scholarships please use the general scholarship [application](#).

#### *Special Requirements for these scholarships:*

The Terry S. Paulson Memorial Scholarship fund (\$5,000) has been established by friends of Terry and Schwarz Partners for **students pursuing further education in the maintenance and engineering area of the corrugated field.**

The Joe Dieffenbacher Engineering Memorial Scholarship fund (\$5000) has been established by the Corrugated Packaging Council of TAPPI to be awarded to a **student interested in entering the engineering area of the corrugated industry.**

- No specific grade point average is required
- Working full time or part time in the corrugated industry and attending day/night school for a graduate or undergraduate degree OR be a full time student in a two-year or a four-year college, university or technical school.
- Demonstrate an interest in the corrugated packaging industry related to maintenance or engineering (part time employment or internships in the corrugated industry are looked upon in a very favorable manner).
- Selection of the scholarship winners will be based on the scholarship committee's opinion of overall maturity, job potential and the candidates' future contribution potential to the corrugated industry.

## General Information Form

Send application to: TAPPI Scholarship Department – TAPPI – 15 Technology Pkwy South, Suite 115

Peachtree Corners, GA 30092 or email: [scholarships@tappi.org](mailto:scholarships@tappi.org)

Address questions to Lisa Lockwood 770-209-7246

**Applicant's Name:** \_\_\_\_\_  
(Last) (First) (Middle)

### Permanent Address

Street \_\_\_\_\_

City \_\_\_\_\_ State/Province \_\_\_\_\_ Postal Code \_\_\_\_\_

Phone \_\_\_\_\_ Email \_\_\_\_\_

**University/College Name:** \_\_\_\_\_

Street \_\_\_\_\_

City \_\_\_\_\_ State/Province \_\_\_\_\_ Postal Code \_\_\_\_\_

Phone \_\_\_\_\_ Email \_\_\_\_\_

### High School and other Universities/Colleges attended:

\_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

**Date of anticipated graduation** \_\_\_\_\_

**Class status as of September following application deadline** (please check the one that applies to you)

- ☐ **Freshman**      ☐ **Sophomore**      ☐ **Junior**      ☐ **Senior**
- ☐ **Continuing Education**

**Main course of study** \_\_\_\_\_

Please explain why you believe you are suitable to receive this scholarship

What single achievement in your life gives you the most pride?

What attracts you to a career in the corrugated industry?

Do you have any corrugated industry employment experience? ☐ Yes ☐ No

If yes, name and contact information of employer:

Name \_\_\_\_\_

Address \_\_\_\_\_

Phone \_\_\_\_\_ Email \_\_\_\_\_

***Please attach a resume and transcript or have your school send it directly to TAPPI if applying by email. It is also possible to scan the letters of recommendation and the transcript and email the whole package to the email provided on page 1 of the General Information Form.***

## Scholarship Checklist

Must be submitted along with the General Information Form

- ☐ Completed Scholarship General Information Form
- ☐ Official Transcript
- ☐ Resume
- ☐ Letter of recommendation from a faculty member or Student Chapter advisor
- ☐ Two additional letters from persons (other than relatives) who are familiar with the applicant's character, interests, activities and accomplishments.

**I hereby acknowledge that the information submitted is true and correct.**

**Signature** \_\_\_\_\_